RF Inductor







Overview

RF inductors are designed to operate at high frequencies, typically in the MHz to GHz range. Unlike power inductors, RF inductors are optimized for signal processing in radio frequency (RF) circuits. They play a vital role in tuning, filtering and impedance matching in communication and signal transmission systems.

Benefits

- 1. High mounting density of compact circuit due to crosstalk elimination that results from a closed magnetic flux in a ferrite material
- 2. Suitable for flow and reflow soldering

Applications

- 1. Personal computers, HDDs, other various electronic devices
- 2. Wearable device
- 3. Consumer Electronics

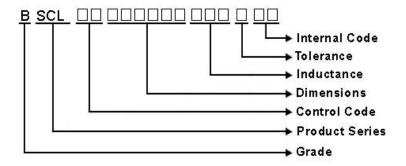
Product Information

Series	Size Code (JIS/EIA)	Inductance (nH)
BSCL	1608/0603	0.1 ~ 27
	2012/0805	
	3216/1206	





- 1 Scope: This specification applies to Multilayer Ferrite chip inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: -40 °C ~ 125 °C(Including self - temperature rise)

Storage Temperature: $-40^{\circ}\text{C} \sim 85^{\circ}\text{C}(\text{after PCB})$

- 5 °C~ 4 0 °C, Humidity 4 0 %~ 7 0 % (before PCB)

4 Marking:

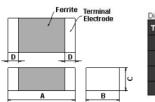
No Marking

5 Standard Testing Condition

	In case of doubt	
Temperature	Ordinary Temperature(15 to 35°C)	20 to 30°C
Humidity Ordinary Humidity(25 to 85% RH)		50 to 80 %RH



6 Configuration and Dimensions:



Dimensions in mm		
TYPE	321611	
А	3.20±0.20	
В	1.60±0.20	
С	1.10±0.20	
D	0.50±0.30	

Net Weight (grms)				
Size Code	Net Weight (grms)			
321611	0.02584			

7 Electrical Characteristics:

Part No.	Inductance (uH)	L,Q Test Freq.	Q Min.	SRF (MHz)Min.	RDC (Ω)Max.	IDC (mA)Max.	Tolerance (±%)
BSCL00321611R10□00	0.1	25 MHZ,200 mV	25	235	0.25	250	20,15,10
BSCL00321611R12□00	0.12	25 MHZ,200 mV	25	220	0.3	250	20,15,10
BSCL00321611R15□00	0.15	25 MHZ,200 mV	25	200	0.3	250	20,15,10
BSCL00321611R18□00	0.18	25 MHZ,200 mV	25	185	0.4	250	20,15,10
BSCL00321611R22□00	0.22	25 MHZ,200 mV	25	170	0.4	250	20,15,10
BSCL00321611R27□00	0.27	25 MHZ,200 mV	25	150	0.5	250	20,15,10
BSCL00321611R33□00	0.33	25 MHZ,200 mV	25	145	0.6	250	20,15,10
BSCL00321611R39□00	0.39	25 MHZ,200 mV	25	135	0.5	200	20,15,10
BSCL00321611R47□00	0.47	25 MHZ,200 mV	25	125	0.6	200	20,15,10
BSCL00321611R56□00	0.56	25 MHZ,200 mV	25	115	0.7	150	20,15,10
BSCL00321611R68□00	0.68	25 MHZ,200 mV	25	105	0.8	150	20,15,10
BSCL00321611R82□00	0.82	25 MHZ,200 mV	25	100	0.9	150	20,15,10
BSCL003216111R0□00	1	10 MHZ,200 mV	45	75	0.4	100	20,15,10
BSCL003216111R2□00	1.2	10 MHZ,200 mV	45	65	0.5	100	20,15,10
BSCL003216111R5□00	1.5	10 MHZ,200 mV	45	60	0.5	80	20,15,10
BSCL003216111R8□00	1.8	10 MHZ,200 mV	45	55	0.5	70	20,15,10
BSCL003216112R2□00	2.2	10 MHZ,200 mV	45	50	0.5	60	20,15,10
BSCL003216112R7□00	2.7	10 MHZ,200 mV	45	45	0.6	60	20,15,10
BSCL003216113R3□00	3.3	10 MHZ,200 mV	45	41	0.7	60	20,15,10
BSCL003216113R9□00	3.9	10 MHZ,200 mV	45	38	0.8	50	20,15,10
BSCL003216114R7□00	4.7	10 MHZ,200 mV	45	35	0.9	50	20,15,10
BSCL003216115R6□00	5.6	4 MHZ,200 mV	45	32	0.7	25	20,15,10
BSCL003216116R8□00	6.8	4 MHZ,200 mV	45	29	0.8	25	20,15,10
BSCL003216118R2□00	8.2	4 MHZ,200 mV	45	26	0.9	25	20,15,10
BSCL00321611100□00	10	2MHz,60 mV	45	24	1	25	20,15,10

NOTE: □-tolerance K=±10% / L=±15% / M=±20%

^{1.} Operating temperature range $-40\,^{\circ}\text{C} \sim 125\,^{\circ}\text{C}$ (Including self - temperature rise)

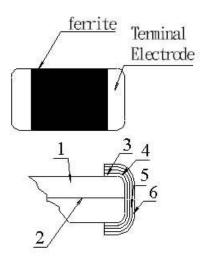
 $^{2.\}mbox{IDC:Applied}$ the current to coils, the inductance shall be less than 10% initial value.



Part No.	Inductance (uH)	L,Q Test Freq.	Q Min.	SRF (MHz)Min.	RDC (Ω)Max.	IDC (mA)Max.	Tolerance (±%)
BSCL00321611120□00	12	2 MHZ,60 mV	45	22	1	15	20,15,10
BSCL00321611150□00	15	1 MHZ,60 mV	35	19	0.7	5	20,15,10
BSCL00321611180□00	18	1 MHZ,60 mV	35	18	0.75	5	20,15,10
BSCL00321611220□00	22	1 MHZ,60 mV	35	16	0.9	5	20,15,10
BSCL00321611270□00	27	1 MHZ,60 mV	35	14	0.9	5	20,15,10



BSCL00321611 Series 8.1 Construction:



8.2 Material List:

No	Part	Material
1	Ferrite Substance	NiO-CuO-ZnO-Ferrite
2	Silver electrode	Ag
3	Silver electrode	Ag
4 Cu plating		Cu
5	Ni plating	Ni
6	Sn plating	Sn



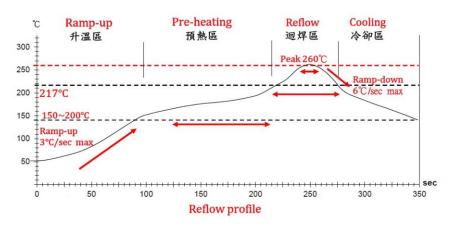
9 Reliability Of Ferrite Multilayer Chip Inductor 1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right conditions must not damage the terminal electrode and the ferrite	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec
1-1-2	Vibration		*For 100505, substrate dimension is 100x40x0.8mm Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10Hz for 1min Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage Inductance change shall be within ±20%. Q change shall be within±30%	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260±5°C Immersion Time: 10±1sec
1-1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 245±5°C (Pb-Free) Immersion Time: 4±1sec

1-2.Environmental Performance

No	Item	Specification		Test Method	
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:		
		Inductance:within±10% of	Step	Temperature (°ℂ)	Time (min)
		initial value	1	-40±3	30
		Q change:within±30% of	2	25±2	3
		initial value	3	125±3	30
			4	25±2	3
			Total: 100c	cycles	
			Measured	after exposure in the room cor	dition for 24hrs
1-2-2	Humidity Resistance		Temperatu	re: 40±2°ℂ	
			Relative H	umidity: 90 ~ 95% / Time: 1000)hrs
			Measured	after exposure in the room cor	dition for 24hrs
1-2-3	High		Temperatu	re: 85±3°ℂ	
	Temperature Resistance		Relative Hu	umidity: 20%	
			Applied Current: Rated Current / Time: 1000hrs		
			Measured	after exposure in the room cor	dition for 24hrs
1-2-4	Low		Temperatu	re: -40±3°ℂ	
	Temperature Resistance		Relative H	umidity: 0% / Time: 1000hrs	
			Measured	after exposure in the room cor	dition for 24hrs





Lead-Free(LF)標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heating	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T ~ 150°C	150°C ~ 200°C	Above 217°C	260±5°C	Peak Temp.~150℃
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result		75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	-

NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow
- 3. Products can only be soldered with reflow



11 Packaging:

11.1 Packaging -Cover Tape

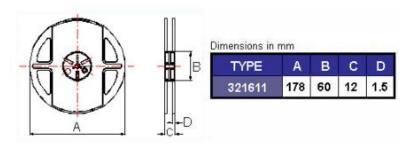
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



11.2 Packaging Quantity

TYPE	PCS/REEL
321611	3000

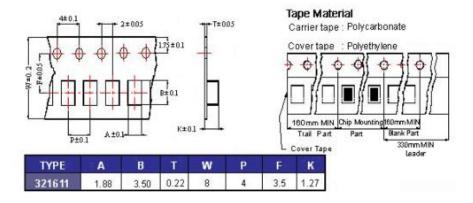
11.3 Reel Dimensions



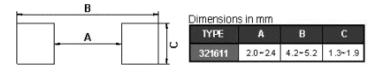


11 Packaging:

11.4 Tape Dimensions in mm



12 Recommended Land Pattern:



13 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. The moisture sensitivity level (MSL) of products is classified as level 1.



